

Vishay Siliconix

RoHS COMPLIANT

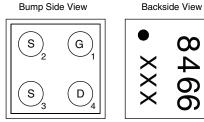
HALOGEN

FREE

N-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	Q _g (Typ.)				
8	0.043 at V _{GS} = 4.5 V	5.4				
	0.046 at V _{GS} = 2.5 V	5.2	6.8 nC			
	0.060 at V _{GS} = 1.5 V	4.6	0.0110			
	0.090 at V _{GS} = 1.2 V	3.0				

MICRO FOOT





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Device Marking: 8466

xxx = Date/Lot Traceability Code

Ordering Information:

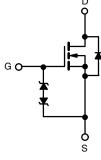
Si8466EDB-T2-E1 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- Typical ESD protection 3000 V HBM
- Ultra-Small 1 mm x 1 mm maximum Outline
- Ultra-Thin 0.548 mm maximum height
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Low On-Resistance Load Switch for Portable Devices
 - Low Power Consumption, Low Voltage Drop
 - Increased Battery Life
 - Space Savings on PCB



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$(T_A = 25 \text{ °C}, \text{ unle})$	ess otherwise	noted)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	8	v	
Gate-Source Voltage		V _{GS}	± 5	v
	T _A = 25 °C		5.4 ^a	
Continuous Drain Current (T 150 °C)	T _A = 70 °C		4.4 ^a	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	۱ _D	3.6 ^b	
	T _A = 70 °C		2.9 ^b	А
Pulsed Drain Current (t = 300 µs)		I _{DM}	20	
Continuous Source-Drain Diode Current	T _C = 25 °C		1.5 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	0.65 ^b	
	T _A = 25 °C		1.8 ^a	
Maximum Dawar Dissinction	T _A = 70 °C	P _D	1.1 ^a	w
Maximum Power Dissipation	T _A = 25 °C		0.78 ^b	vv
	T _A = 70 °C		0.5 ^b	1
Operating Junction and Storage Temperature Rar	T _J , T _{stg}	- 55 to 150		
Pookage Beflow Conditions	VPR		260	°C
Package Reflow Conditions ^c	IR/Convection		260	1

Notes:

a. Surface mounted on 1" x 1" FR4 board with full copper, t = 10 s.

b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 10 s.

c. Refer to IPC/JEDEC (J-STD-020), no manual or hand soldering.

d. In this document, any reference to case represents the body of the MICRO FOOT device and foot is the bump.

e. Based on $T_A = 25$ °C.

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THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{a, b}	t = 10 s	R _{thJA}	55	70	°C/W			
Maximum Junction-to-Ambient ^{c, d}	t = 10 s	' 'thJA	125	160	0/10			

Notes:

a. Surface mounted on 1" x 1" FR4 board with full copper.

b. Maximum under steady state conditions is 100 °C/W.

c. Surface mounted on 1" x 1" FR4 board with minimum copper.

d. Maximum under steady state conditions is 190 °C/W.

SPECIFICATIONS (T _J = 25 Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	8			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		3.5		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.35		0.7	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 5 V$			± 3	μΑ	
		$V_{DS} = 8 V, V_{GS} = 0 V$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 8 V, V_{GS} = 0 V, T_{J} = 70 °C$	= 70 °C		10	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2 \text{ A}$		0.035	0.043	- Ω	
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$		0.037	0.046		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 1.5 V, I _D = 1 A		0.045	0.060		
		$V_{GS} = 1.2 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		0.055	0.090		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 4 V, I_{D} = 2 A$		30		S	
Dynamic ^b	· · · · ·		•	•		•	
Input Capacitance	C _{iss}			710			
Output Capacitance	C _{oss}	V_{DS} = 4 V, V_{GS} = 0 V, f = 1 MHz		270		pF	
Reverse Transfer Capacitance	C _{rss}			192			
Total Gate Charge	Qg			8.5	13		
Gate-Source Charge	Q _{gs}	V_{DS} = 4 V, V_{GS} = 4.5 V, I_D = 2 A		0.9		nC	
Gate-Drain Charge	Q _{gd}			1.6			
Gate Resistance	Rg	$V_{GS} = 0.1 V$, f = 1 MHz	1	6		Ω	
Turn-On Delay Time	I-On Delay Time t _{d(on)}			10	20	-	
Rise Time	t _r	t_r $V_{DD} = 4 V, R_L = 2 \Omega$		15	30		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 2 A, V_{GEN} = 4.5 V, R_g = 1 Ω		40	80	ns	
Fall Time	t _f			10	20]	

Document Number: 63683 S12-2183-Rev. A, 10-Sep-12

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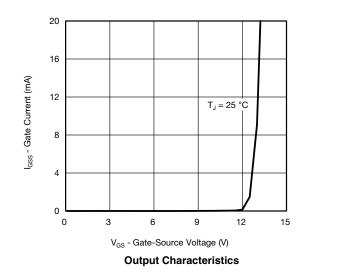
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	$I_{\rm S}$ $T_{\rm A} = 25 ^{\circ}{\rm C}$				1.5	•	
Pulse Diode Forward Current	I _{SM}				20	A	
Body Diode Voltage	V _{SD}	I _S = 1.5 A, V _{GS} = 0		0.7	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 2 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		7	15	nC	
Reverse Recovery Fall Time	t _a	1^{-2} X_{1} $u_{1}u_{1} = 100$ $X_{1}\mu_{3}$, 1^{-20} U_{1}		15		ns	
Reverse Recovery Rise Time	t _b			15		115	

Notes:

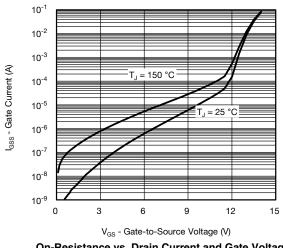
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Drain Current and Gate Voltage

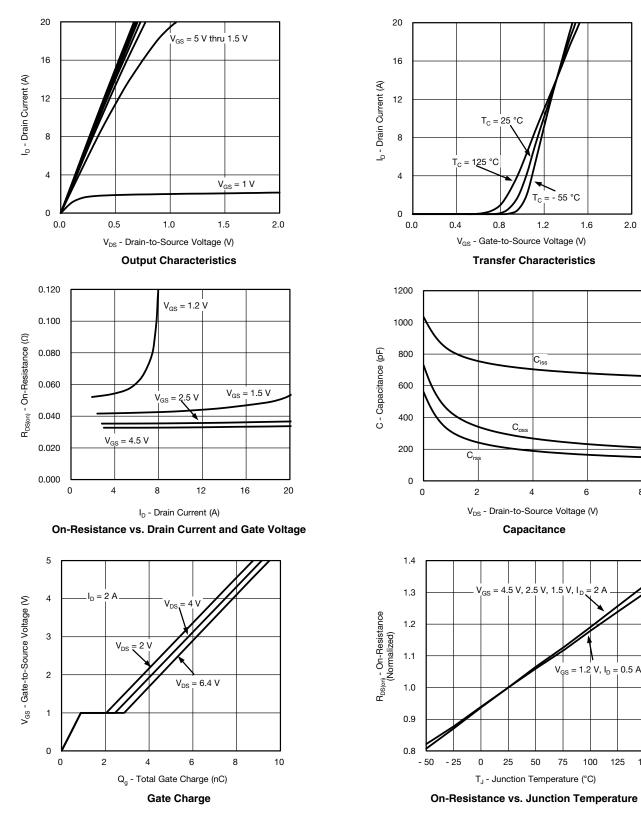
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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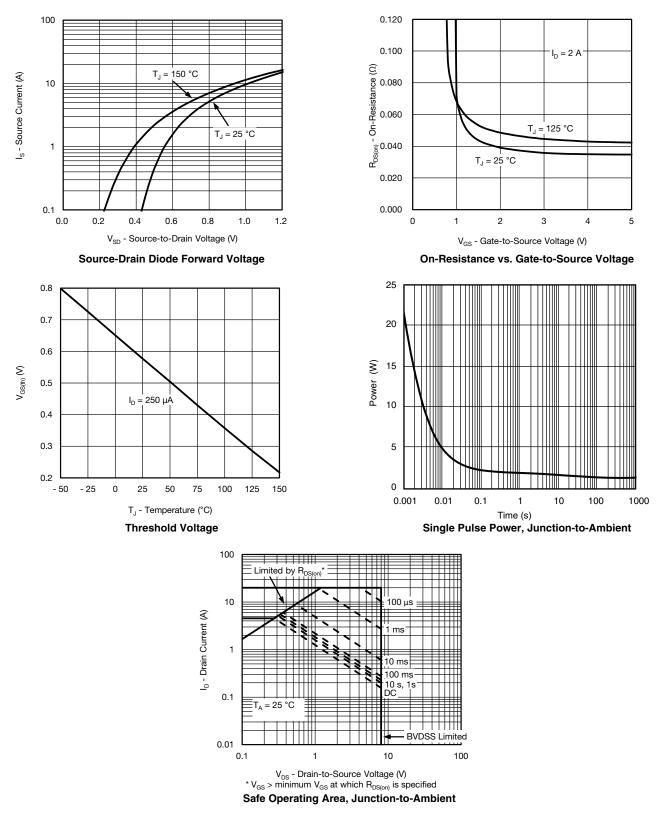
125 150

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Si8466EDB Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

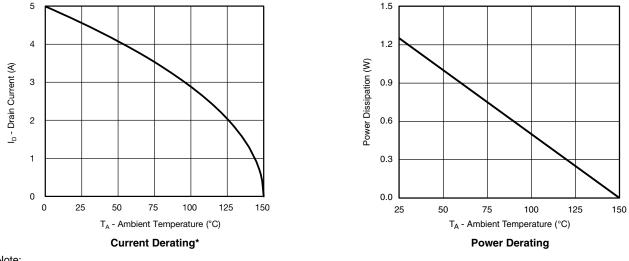


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note: When Mounted on 1" x 1" FR4 with Full Copper.

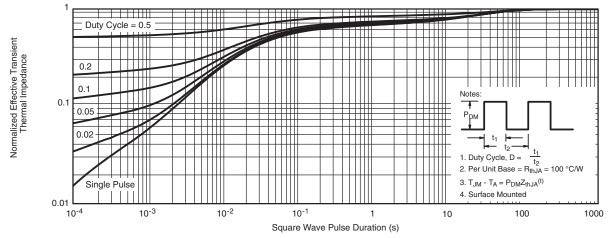
* The power dissipation P_D is based on $T_{J(max.)} = 150 \text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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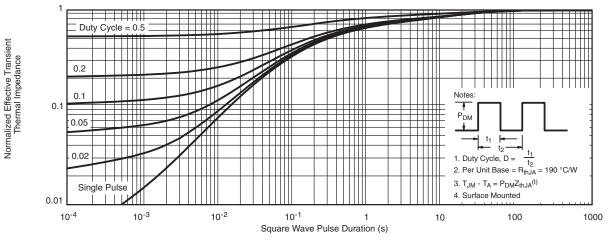


Si8466EDB Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (1" x 1" FR4 Board with Full Copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (1" x 1" FR4 Board with Minimum Copper)

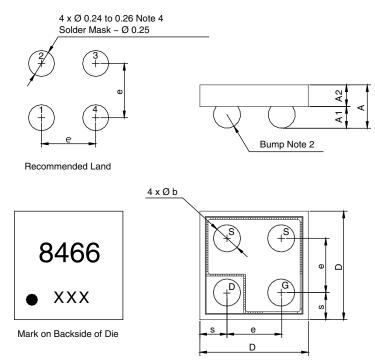
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PACKAGE OUTLINE

MICRO FOOT 1 mm x 1 mm: 4-BUMP (2 x 2, 0.5 mm PITCH)



Notes (Unless otherwise specified):

1. All dimensions are in millimeters.

2. Four (4) solder bumps are lead (Pb)-free 95.5Sn/3.8Ag/0.7Cu with diameter Ø 0.30 mm to 0.32 mm.

3. Backside surface is coated with a Ti/Ni/Ag layer.

4. Non-solder mask defined copper landing pad.

5. • is location of pin 1.

Dim.		Millimeters ^a		Inches			
	Min.	Nom.	Max.	Min.	Nom.	Max.	
Α	0.462	0.505	0.548	0.0181	0.0198	0.0215	
A ₁	0.220	0.250	0.280	0.0086	0.0098	0.0110	
A ₂	0.242	0.255	0.268	0.0095	0.0100	0.0105	
b	0.300	0.310	0.320	0.0118	0.0122	0.0126	
е	0.500			0.0197			
S	0.230	0.250	0.270	0.0090	0.0098	0.0106	
D	0.920	0.960	1.000	0.0362	0.0378	0.0394	

Notes:

a. Use millimeters as the primary measurement.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63683.



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